





SURFACE MOUNT FAST SWITCHING DIODE

Features

- Fast Switching Speed
- Ultra-Small Surface Mount Package
- Low Reverse Leakage Current
- Ideal for Battery Powered Portable Applications
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: X1-DFN1006-2
- Case Material: Molded Plastic, "Green" Molding Compound;
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Marking Information
- Terminals: Finish—NiPdAu over Copper Leadframe;
 Solderable per MIL-STD-202, Method 208 64
- Weight: 0.001 grams (Approximate)

X1-DFN1006-2



Bottom View



Device Schematic

Ordering Information (Note 4)

Part Number	Case	Packaging
1N4448HLP-7	X1-DFN1006-2	3000/Tape & Reel
1N4448HLP-7B	X1-DFN1006-2	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information (Note 5)

1N4448HLP-7

• T8

Top View Dot Denotes Cathode Side

T8

Top View
Bar Denotes

Cathode Side

1N4448HLP-7B



Top View Bar Denotes Cathode Side T8 = Product Type Marking Code

Note: 5. From date code 1527 (YYWW), dot marking was changed to bar marking for 1N4448HLP-7.



Maximum Ratings (@T_A = +25°C unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage		V_{RM}	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _R WM V _R	80	V
RMS Reverse Voltage		V _{R(RMS)}	57	V
Forward Continuous Current		I _{FM}	300	mA
Average Rectified Output Current		lo	95	mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0µs @ t = 1.0s	I _{FSM}	2.0 1.0	А

Thermal Characteristics

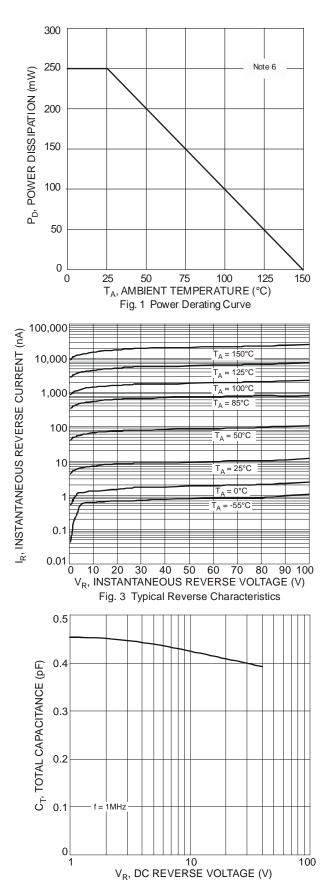
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	P_{D}	250	mW
Thermal Resistance Junction to Ambient (Note 6)	$R_{\Theta JA}$	500	°C/W
Operating and Storage Temperature Range	T_J,T_STG	-65 to +150	°C

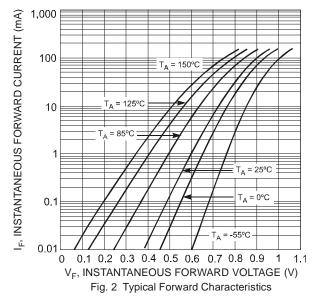
Electrical Characteristics @T_A = 25°C unless otherwise specified

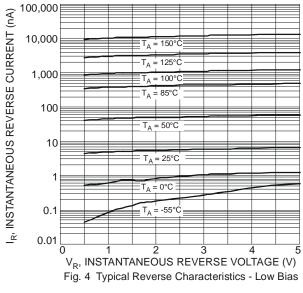
Characteristic	Symbol	Min	Max	Unit	Test Conditions
Reverse Breakdown Voltage (Note 7)	$V_{(BR)R}$	80		V	$I_R = 100 \mu A$
	VF	0.62	0.72	V	$I_F = 5.0 \text{mA}$
Forward Voltage		_	0.855		$I_F = 10mA$
1 orward voltage		_	1.0		$I_F = 100 \text{mA}$
		_	1.25		I _F = 150mA
	1_		100	nA	$V_R = 80V$
Peak Reverse Current (Note 7)			50	μΑ	$V_R = 75V, T_J = +150$ °C
reak Reverse Current (Note 1)	I _R	_		μΑ	$V_R = 25V, T_J = +150$ °C
			25	nA	$V_R = 20V$
Total Capacitance	C _T	_	3.0	pF	$V_R = 0.5V, f = 1.0MHz$
Reverse Recovery Time	+		_ 4.0	ns	$I_F = I_R = 10 \text{mA},$
Trevelse recovery fillie	t _{rr}	r —			$I_{rr} = 0.1 \times I_{R}, R_{L} = 100\Omega$

^{6.} Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com. 7. Short duration pulse test used to minimize self-heating effect.









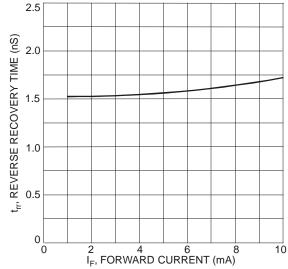


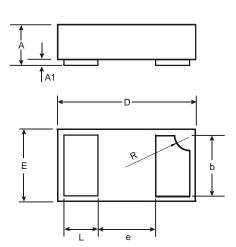
Fig. 6 Typical Reverse Recovery Time vs. Forward Current

Fig. 5 Typical Total Capacitance vs. Reverse Voltage



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.



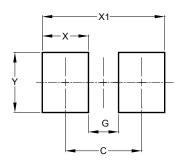
X1-DFN1006-2

X1-DFN1006-2				
Dim	Min	Max	Тур	
Α	0.47	0.53	0.50	
A1	0	0.05	0.03	
b	0.45	0.55	0.50	
D	0.95	1.075	1.00	
Е	0.55	0.675	0.60	
е	ı	1	0.40	
L	0.20	0.30	0.25	
R	0.05	0.15	0.10	
All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

X1-DFN1006-2



Dimensions	Value (in mm)		
С	0.70		
G	0.30		
Х	0.40		
X1	1.10		
Υ	0.70		



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